Effective June 2017 Supersedes September 2012

FP1007R6 High frequency, high current power inductors



Product features

- 10.5 x 8.0 x 7.0mm Maximum surface mount package
- Ferrite core material
- Controlled DCR tolerance for sensing circuits
- Inductance Range from 150nH to 470nH
- Current range from 23.5 to 75 Amps
- Frequency range up to 2MHz
- Halogen free, lead free, RoHS compliant

Applications

- Multi-phase regulators
- Voltage Regulator Modules (VRMs)
- Desktop and server VRMs and EVRDs
- Data networking and storage systems
- · Graphics cards and battery power systems
- Point-of-Load modules
- DCR Sensing

Environmental data

- Storage temperature range (component): -40 °C to +125 °C
- Operating temperature range: -40 °C to +125 °C (ambient plus self-temperature rise)
- Solder reflow temperature:
 J-STD-020 (latest revision) compliant





FP1007R6 High frequency, high current power inductors

5. Isat2: Peak current for approximately 20% rolloff at +100°C.

Δl (peak-to-peak ripple current in Amps). 7. Part Number Definition: FP1007R6-Rxx-R

Rxx= Inductance value in uH, R = decimal point

FP1007R6 = Product code and size

-R suffix = RoHS compliant

6. K-factor: Used to determine Bp-p for core loss (see graph). Bp-p = K * L

* ΔI * 10⁻³. Bp-p:(Gauss), K: (K-factor from table), L: (Inductance in nH),

			Product S	pecifications			
Part	OCL ¹ ±10%	FLL ² Min.	Irms ³	I _{sat} 1 ⁴ @25°C	Isat 2 ⁵ @100°C	DCR @20°C	
Number ⁷	(nH)	(nH)	(Amps)	(Amps)	(Amps)	(mΩ)	K-Factor ⁶
FP1007R6-R15-R	150	108		75.0	60.0		
FP1007R6-R18-R	180	129		60.0	50.0		
FP1007R6-R22-R	220	158	-	50.0	40.0	-	
FP1007R6-R27-R	270	194	61	41.0	33.0	0.29 ± 5%	348.8
FP1007R6-R33-R	330	237	-	33.0	26.5		
FP1007R6-R39-R	390	280	-	28.0	22.5		
FP1007R6-R47-R	470	338		23.5	19.0		

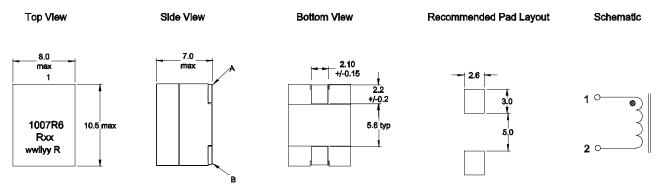
1. Open Circuit Inductance (OCL) Test Parameters: 100kHz, 0.10Vrms, 0.0Adc

2. Full Load Inductance (FLL) Test Parameters: 100kHz, 0.1Vrms, Isat1

3. I_{rms}: DC current for an approximate temperature rise of 40°C without core loss. Derating is necessary for AC currents. PCB layout, trace thickness and width, air-flow, and proximity of other heat generating components will affect the temperature rise. It is recommended that the temperature of the part not exceed 125°C under worst case operating conditions verified in the end application.

4. Isat1: Peak current for approximately 20% rolloff at +25°C.

Dimensions- mm



The nominal DCR is measured from point "A" to point "B"

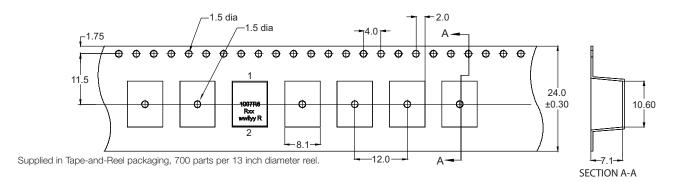
Part Marking: 1007R6, Rxx = Inductance value in µH. (R = Decimal point) wwllyy = Date code R = Revision level Tolerance are

 ± 0.15 mm unless otherwise specified.

Soldering surfaces to be coplanar within 0.1016mm.

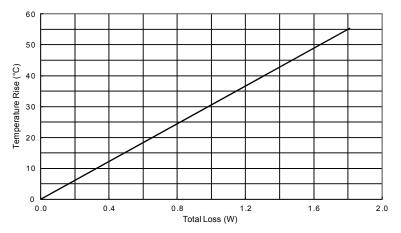
PCB tolerance ±0.1mm unless otherwise specified.

Packaging information - mm

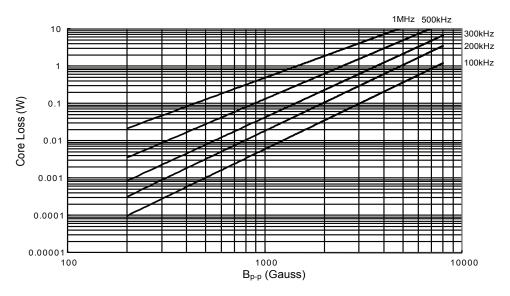


FP1007R6 High frequency, high current power inductor

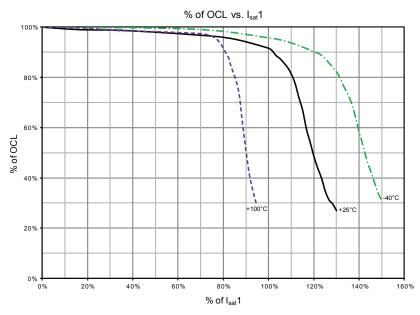
Temperature rise vs total loss



Core loss vs Bp-p







Solder Reflow Profile

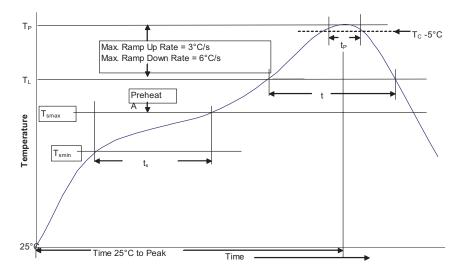


Table 1 - Sta	able 1 - Standard SnPb Solder (T _C)				
	Volume	Volume			
Package	mm ³	mm ³			
Thickness	<350	≥350			
<2.5mm	235°C	220°C			
≥2.5mm	220°C	220°C			
Table 2 - Lea	ad (Pb) Fre	e Solder (T _C)			
Table 2 - Lea	ad (Pb) Fre Volume	e Solder (T _C) Volume	Volume		
Table 2 - Lea Package		· ·	Volume mm ³		
	Volume	Volume			
Package	Volume mm ³	Volume mm ³	mm ³		
Package Thickness	Volume mm ³ <350 260°C	Volume mm ³ 350 - 2000	mm ³ >2000		

Reference JDEC J-STD-020

Profile Feature		Standard SnPb Solder	Lead (Pb) Free Solder	
Preheat and Soak	 Temperature min. (T_{smin}) 	100°C	150°C	
	 Temperature max. (T_{smax}) 	150°C	200°C	
	 Time (T_{smin} to T_{smax}) (t_s) 	60-120 Seconds	60-120 Seconds	
Average ramp up rate T _{smax} to T _p		3°C/ Second Max.	3°C/ Second Max.	
Liquidous temperature (TL)		183°C	217°C	
Time at liquidous (t _L)		60-150 Seconds	60-150 Seconds	
Peak package body temperature (TP)*		Table 1	Table 2	
Time $(t_p)^{\star\star}$ within 5 °C of the specified classification temperature (T_c)		20 Seconds**	30 Seconds**	
Average ramp-down rate (Tp to Tsmax)		6°C/ Second Max.	6°C/ Second Max.	
Time 25°C to Peak Temperature		6 Minutes Max.	8 Minutes Max.	

 * Tolerance for peak profile temperature (T_p) is defined as a supplier minimum and a user maximum.

** Tolerance for time at peak profile temperature (t_p) is defined as a supplier minimum and a user maximum.

Life Support Policy: Eaton does not authorize the use of any of its products for use in life support devices or systems without the express written approval of an officer of the Company. Life support systems are devices which support or sustain life, and whose failure to perform, when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user.

Eaton reserves the right, without notice, to change design or construction of any products and to discontinue or limit distribution of any products. Eaton also reserves the right to change or update, without notice, any technical information contained in this bulletin.

Eaton Electronics Division 1000 Eaton Boulevard Cleveland, OH 44122 United States www.eaton.com/electronics

© 2017 Eaton All Rights Reserved Printed in USA Publication No. 10007 BU-SB12795 June 2017

Eaton is a registered trademark.

All other trademarks are property of their respective owners.



Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Eaton:

 FP1007R2-R12-R
 FP1007R2-R14-R
 FP1007R2-R17-R
 FP1007R6-R22-R
 FP1007R6-R39-R
 FP1007R6-R15-R

 FP1007R6-R18-R
 FP1007R6-R27-R
 FP1007R6-R33-R
 FP1007R6-R47-R
 FP1007R2B-R22-R
 FP1007R3-R22-I

 FP1007R3-R15-I
 FP1007R3-R15-I
 FP1007R3-R15-I
 FP1007R3-R15-I
 FP1007R3-R15-I